

FUTURE UDIMM DDR5

Introduction

HIKSEMI memory module FUTURE UDIMM is a DDR5 memory module, which is made of high-quality DRAM chips and mature production technology, which makes it more compatible, stable and cost-effective. Can be widely used in PC installations, various high-bandwidth, high-performance system applications



Features

- Cost-effective
Adopt selected IC to make the system run stably and perform better.
- Good compatibility
Better compatibility, compatible with more products after HIKSEMI optimization.

Ordering Information

Frequency	Capacity	Model
6000MHz	16GB	HSC516U60C4
	32GB	HSC532U60C4
6400MHz	16GB	HSC516U64C4
	32GB	HSC532U64C4
6800MHz	16GB	HSC516U68C4
	32GB	HSC532U68C4
7200MHz	16GB	HSC516U72C4
	32GB	HSC532U72C4
7600MHz	16GB	HSC516U76C4
	32GB	HSC532U76C4
8000MHz	16GB	HSC516U80C4
	32GB	HSC532U80C4

Note

Please contact the local sales for detailed model information.

Specification

Name	FUTURE UDIMM DDR5	
Capacity	16GB	32GB
Interface	DDR5	
frequency	6000/6400/6800/7200/7600/8000MHz	
Overclock model	XMP/EXPO	
Pin	288pin	
PCB Size(L×W×H mm)	133.25*31.25*3.77	
Operation temperature	0 °C to 85 °C (32 °F to 185 °F)	
Limited warranty period	Lifetime warranty	
Weight	70g	

Revision History

Version	Description	Date
V1.0.0	FUTURE UDIMM DDR5	20240314

Data subject to change without notice.

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The Manual includes instructions for using and managing the Product. Pictures, charts, images and all other information hereinafter are for description and explanation only. The information contained in the Manual is subject to change, without notice, due to firmware updates or other reasons. Please find the latest version of this Manual at the HIKSTORAGE website (www.hiksemitech.com).